



# PRODUCT DATASHEET



- Ceramic High Power
- ➤ 3939 1.61t Series
- IR 940nm / IR 850nm
  / Deep Red 660nm /
  True Green 525nm



# 3939 1.61t Series



# FEATURES (IR 940/IR 850/Red/Green\*):

- Package: Ceramic SMT Package with Glass Lens
- Forward Current: 150/150/150/150mA
- Forward Voltage (typ.): 1.6/1.6/2.3/3.2V
- Luminous Power/Flux (typ.): 40/40/12mW/18lm@150mA
- **Colour:** IR 940nm/IR 850nm/Deep Red/True Green
- Wavelength: 940/850/660/525nm
- Viewing angle: 120°
- Materials:
  - Die: AlGaInP/AlGaInP/AlGaInP/InGaN
  - Resin: Glass (Water Clear)
- Operating Temperature: -40~+80°C
- Storage Temperature: -40~+80°C
- Grouping parameters:
  - Forward voltage
  - Luminous flux
  - Peak Wavelength
- Soldering methods: IR Reflow soldering
- Preconditioning: MSL 4 according to J-STD020
- **Packing:** 12mm tape with max.2500pcs/reel, ø180mm (7")



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NOM62S47

3939 1.61t Series

**APPLICATIONS:** 

Light Inspection

**Detection Device** 

Medical Device

Plant Light



# **CHARACTERISTICS:**

### Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	lf	200	mA
Pulse Current D=0.01s Duty 1/10	IFP	300	mA
Reverse Voltage	V <sub>R</sub>	-5	V
Reverse Current @5V	I <sub>R</sub>	10	μΑ
Junction Temperature	Tj	85	°C
Thermal Resistance	R <sub>TH</sub>	17.8	°C/W
Soldering Temperature	T <sub>sol</sub>	260	°C
Operating Temperature	Topr	-40~+80	°C
Storage Temperature	T <sub>STG</sub>	-40~+80	°C



•	Values					Test
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
IR 940nm - Forward Voltage	VF	1.3		1.8	V	I⊧=150mA
IR 940nm - Luminous Power	Po	30		50	mW	I <sub>F</sub> =150mA
IR 940nm - Wavelength	WP	930		950	nm	I⊧=150mA
IR 850nm - Forward Voltage	VF	1.3		1.8	V	I⊧=150mA
IR 850nm - Luminous Power	Po	30		50	mW	I⊧=150mA
IR 850nm - Wavelength	Wp	840		860	nm	I⊧=150mA
Red - Forward Voltage	VF	1.8		2.8	V	I⊧=150mA
Red - Luminous Flux	Po	10		13	mW	I⊧=150mA
Red - Wavelength	WP	650		670	nm	I⊧=150mA
Green - Forward Voltage	VF	2.6		3.8	V	I⊧=150mA
Green - Luminous Flux	Φv	17		20	lm	I⊧=150mA
Green - Wavelength	Wp	520		530	nm	I⊧=150mA
Viewing Angle	2 <b>θ</b> 1/2		120		deg	I⊧=150mA

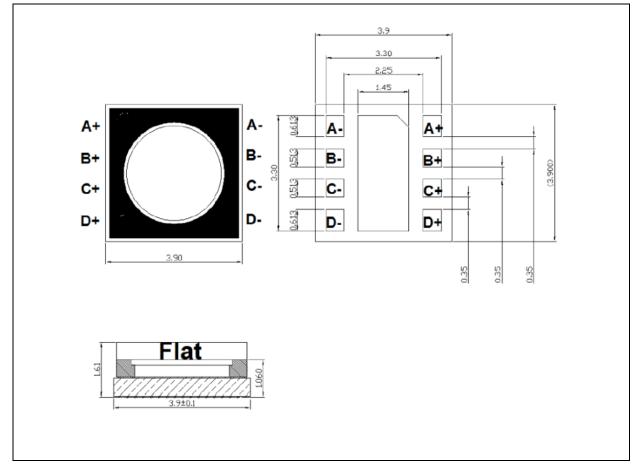
#### Electrical & Optical Characteristics (Ta=25°C)

1. Luminous intensity ( $I_V$ ) ±10%, Forward Voltage ( $V_F$ ) ±0.1V



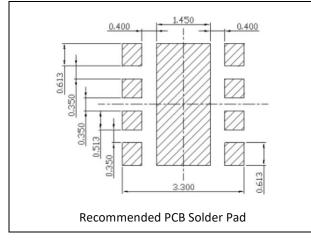
## **OUTLINE DIMENSION:**

#### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

#### Recommended Soldering Pad Dimension:

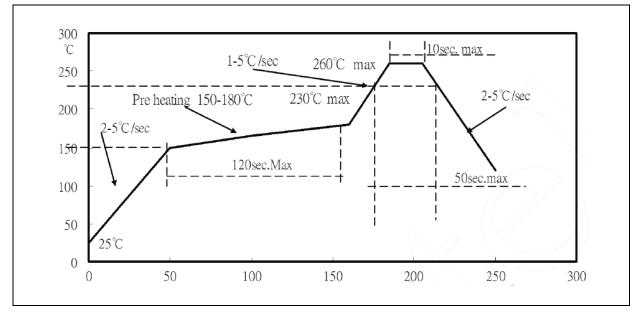


- 1. Dimensions are in millimetre (mm).
- 2. Tolerance  $\pm 0.1$ mm with angle tolerance  $\pm 0.5^{\circ}$ .



### **RECOMMENDED SOLDERING PROFILE:**

#### Lead-free Solder:



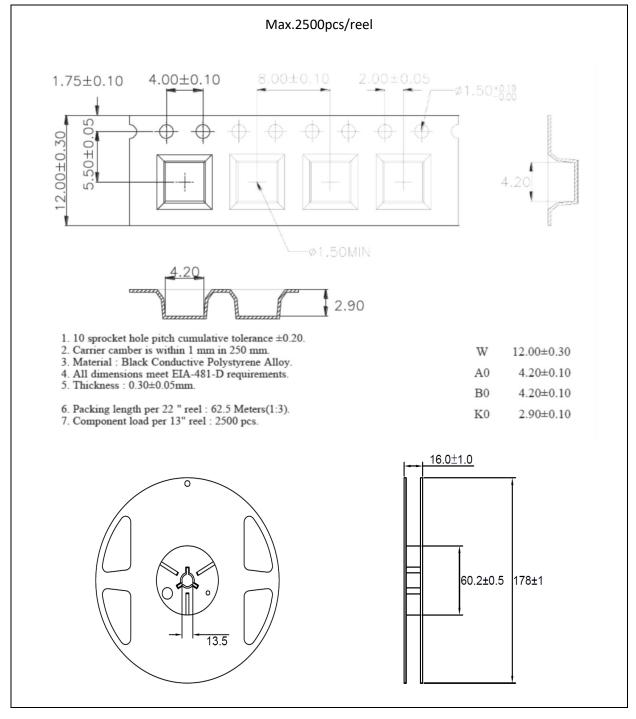
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. The recommended reflow temperature is 240°C. The maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



## **PACKING SPECIFICATION:**

#### Reel Dimension:



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## **PRECAUTIONS OF USE:**



#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

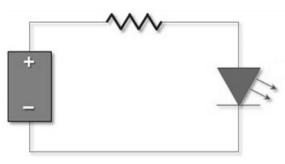
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	08/09/2022	Datasheet set-up.